

June 1999

FDC638P P-Channel 2.5V Specified PowerTrench[™] MOSFET

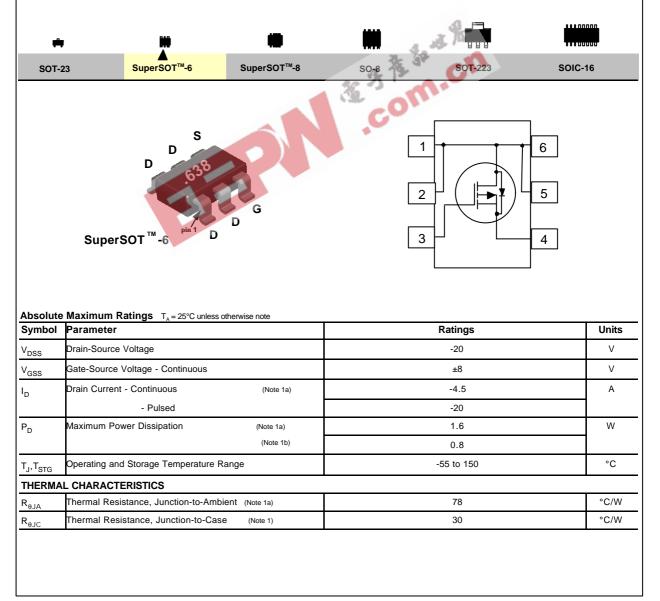
General Description

This P -Channel 2.5V specified MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

These devices are well suited for battery power applications: load switching and power management, battery charging circuits, and DC/DC conversion.

Features

- -4.5 A, -20 V. $R_{DS(ON)} = 0.045 \Omega$ @ $V_{GS} = -4.5 V$ $R_{DS(ON)} = 0.065 \Omega$ @ $V_{GS} = -2.5 V.$
- Low gate charge (13nC typical).
- High performance trench technology for extremely low R_{DS(ON)}.
- SuperSOTTM-6 package: small footprint (72% smaller than standard SO-8); low profile (1mm thick).



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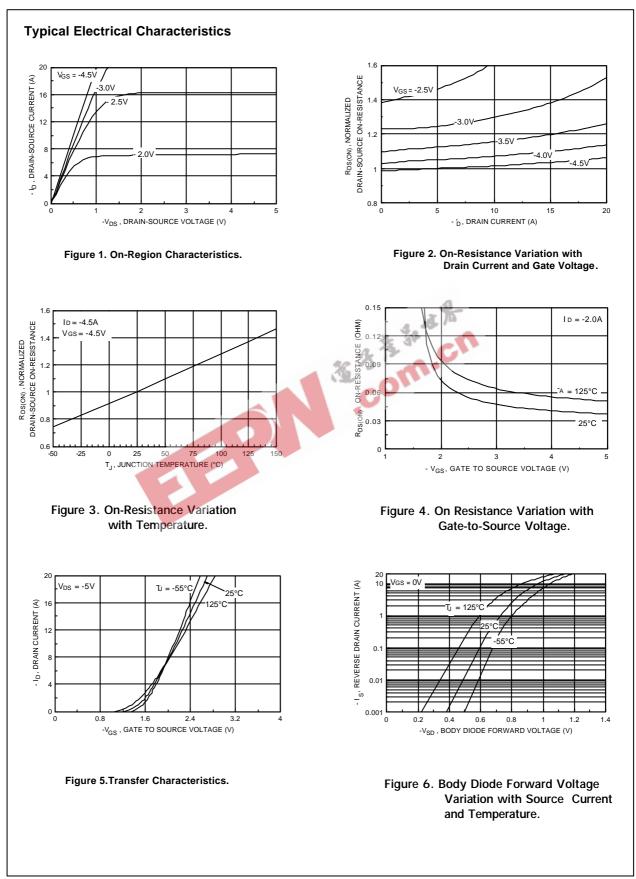
Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF CHARA	ACTERISTICS					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA	-20			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25 °	C	-18		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -16 V, V _{GS} = 0 V			-1	μA
		T _J = \$	55 °C		-10	μA
I _{GSSF}	Gate - Body Leakage, Forward	V _{GS} = 8 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate - Body Leakage, Reverse	$V_{GS} = -8 V, V_{DS} = 0 V$			-100	nA
ON CHARA	CTERISTICS (Note 2)				-	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.4	-0.9	-1.5	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold VoltageTemp.Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25 °	C	3		mV/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} = -4.5 V, I _D = -4.5 A		0.039	0.045	Ω
		$T_J = T_J$	125 °C	0.054	0.072	1
		V _{GS} = -2.5 V, I _D = -3.8 A		0.057	0.065	1
I _{D(on)}	On-State Drain Current	$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	-20			Α
9 _{FS}	Forward Transconductance	$V_{GS} = -4.5 V, V_{DS} = -5 V$ $V_{DS} = -10 V, I_D = -4.5 A$ $V_{DS} = -10 V, V_{GS} = 0 V,$	5.14	6.5		S
DYNAMIC C	CHARACTERISTICS	1 12 3	C			
C _{iss}	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		1240		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		270		pF
C _{rss}	Reverse Transfer Capacitance			100		pF
SWITCHING	CHARACTERISTICS (Note 2)					
t _{D(on)}	Turn - On Delay Time	$V_{DD} = -5 V, I_D = -1 A,$		8	16	ns
t _r	Turn - On Rise Time	$V_{ m GS}$ = -4.5 V, R $_{ m GEN}$ = 6 Ω		15	27	ns
t _{D(off)}	Turn - Off Delay Time			45	65	ns
t _f	Turn - Off Fall Time			30	50	ns
Q _g	Total Gate Charge	$V_{DS} = -10 V$, $I_{D} = -4.5 A$,		13	19	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -5 V$		1.8		nC
Q _{gd}	Gate-Drain Charge			3		nC
DRAIN-SOU	RCE DIODE CHARACTERISTICS					
s	Continuous Source Diode Current				-1.3	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -1.3 A$ (Note 2)		-0.75	-1.2	V

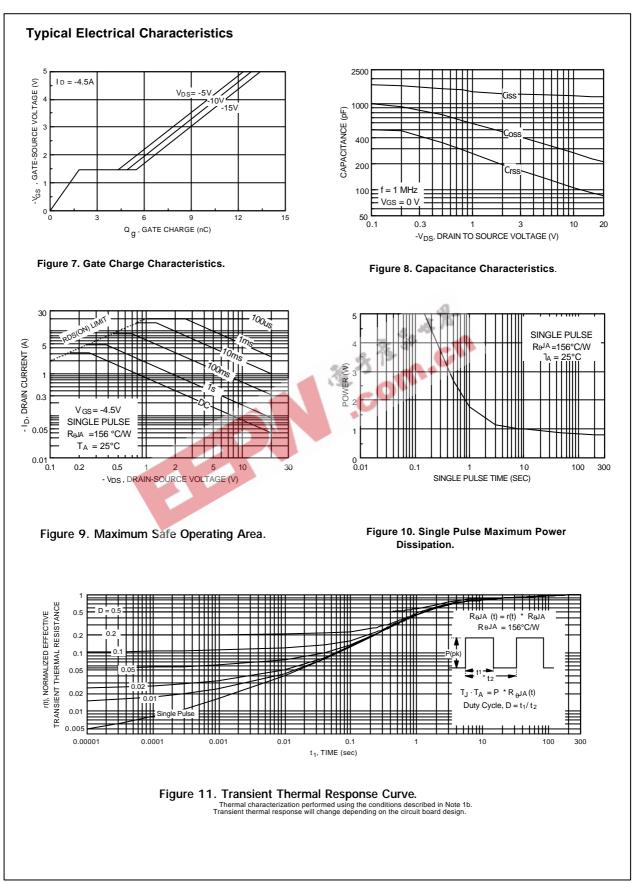
Notes: 1. R_{8.4} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{8.6} is guaranteed by design while $\mathrm{R}_{_{\mathrm{BCA}}}$ is determined by the user's board design.

a. 78°C/W when mounted on a 1 in² pad of 2oz Cu on FR-4 board.

b. 156°C/W when mounted on a minimum pad.

2. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.





FDC638P Rev.B

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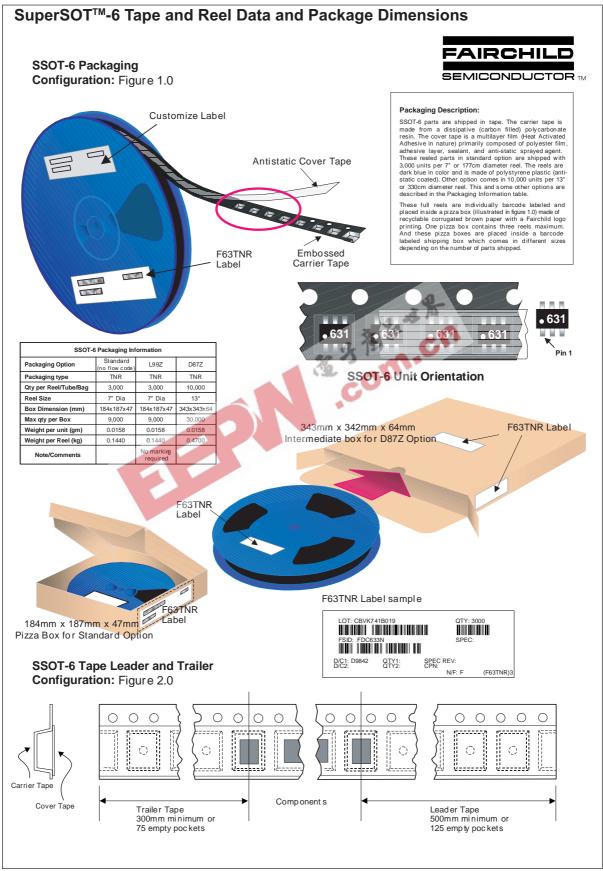
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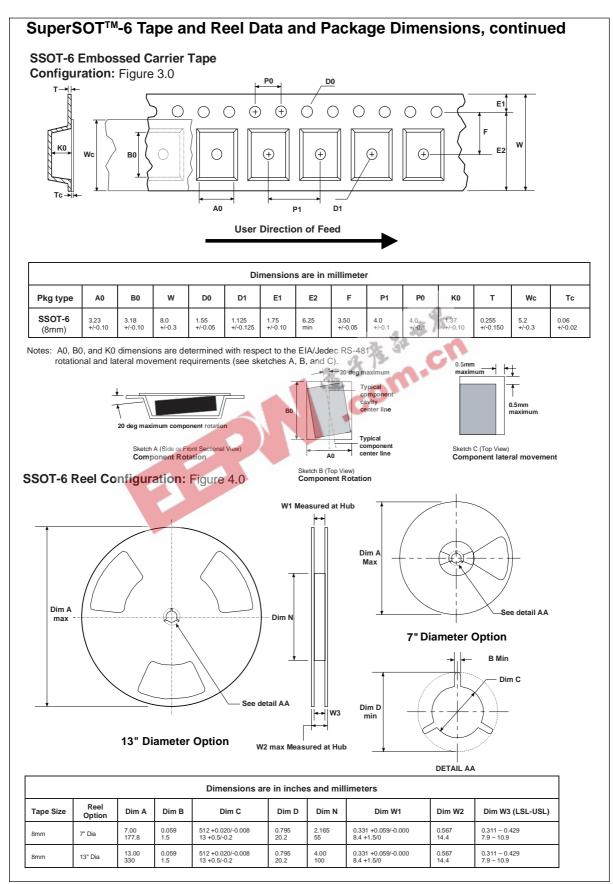
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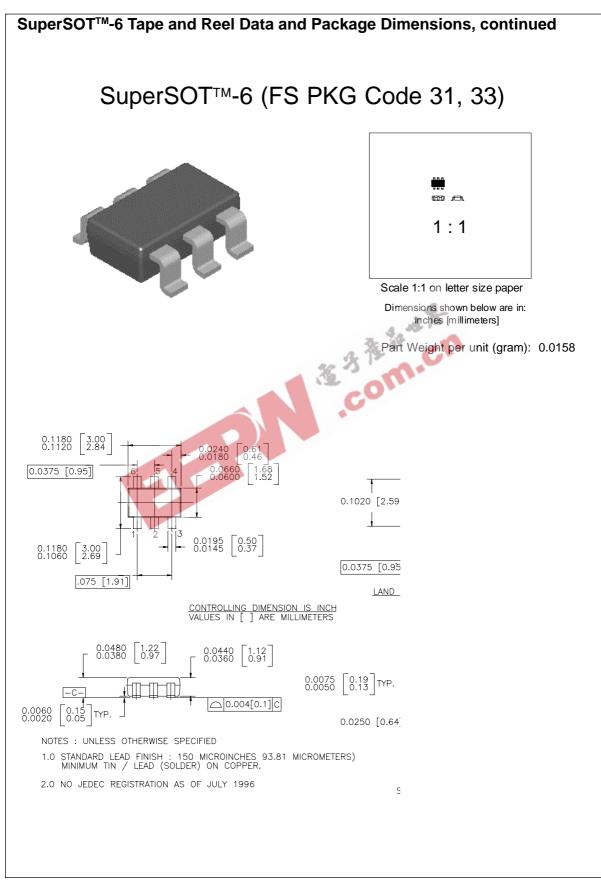
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